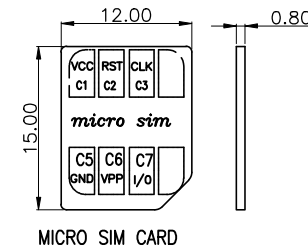
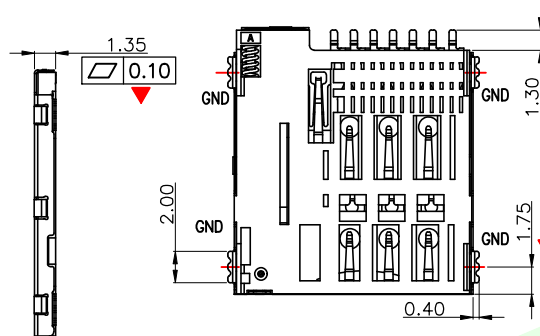
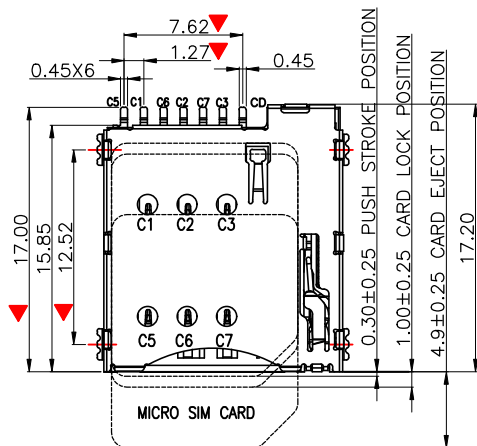
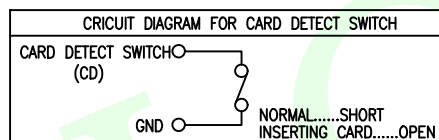
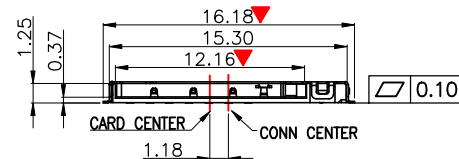
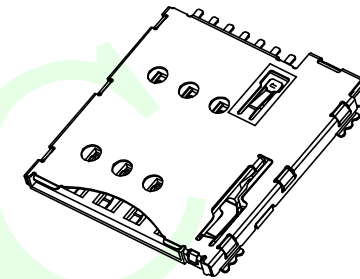


RoHS Compliant



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

PLATING:

Contact: Plated 30u" Ni Overall ,Solder Area: Tin,Contact G/F
Shell: Plated 30u" Ni Overall
Plated G/F Selective Contact Area

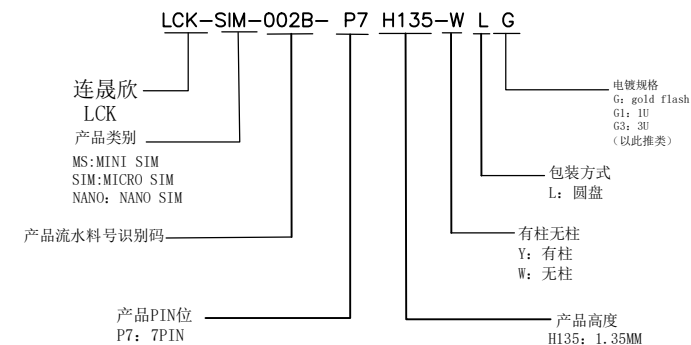
Electrical:

Current Rating :0.5mA max.
Voltage Rating :50V DC MAX
Ambient Temperature Range :-20°C~+85°C
Storage Temperature Range :-40°C~+70°C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩ max.
Insulation Resistance:100MΩ min./250V DC
Dielectric Withstanding Voltage:500V AC
Mating Cycles:5,000 Insertions
Temperature: 260°C ±5°

■ CIRCUIT TRACE KEEP OUT AREA
■ SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



MEASURE POINT:

QUADRANT POINT (QP)
TANGENCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE
SPECIFIED, TOLERANCE:

X. ±0.25
X.x ±0.20
X.xx ±0.15
ANGULAR ±3°

联晟欣连接器 (深圳) 有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24	TITLE:	MICRO SIM PUSH PUSH 1.35H		
CHECKED		DATE			7P带CD脚无柱		
APPROVED		DATE					
PART NO:	LCK-SIM-002B-P7H135-WLG	REV:	04	SCALE:	1:1	UNIT:	mm
DRAWING NO:		SIZE:	A4	SHEET:	1/1		